

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4536799

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUNG EUN HAN	09/01/2016
DONG GEUN SHIN	11/28/2016
BYUNG SOOK KIM	09/01/2016
RECEIVING PARTY DATA	
Name:	LG INNOTEK CO., LTD.
Street Address:	17TH FLOOR, LG SEOULSTATIONBUILDING
Internal Address:	98, HUAM-RO, JUNG-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	04637
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14369049
CORRESPONDENCE DATA	
Fax Number:	(352)372-5800
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	352-375-8100
Email:	JL@SLEPATENTS.COM
Correspondent Name:	JEFF LLOYD
Address Line 1:	PO BOX 142950
Address Line 4:	GAINESVILLE, FLORIDA 32614-2950
ATTORNEY DOCKET NUMBER:	SUN.LGI.700
NAME OF SUBMITTER:	JEFF LLOYD
SIGNATURE:	/JEFF LLOYD/
DATE SIGNED:	08/04/2017
Total Attachments: 4	
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Docket No. SUN.LGI.700

COMBINED DECLARATION (37 C.F.R. § 1.63) AND ASSIGNMENT

As a below-named inventor, I hereby declare that:

I believe I am the original inventor or an original joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

Insert Title:

SILICON CARBIDE POWDER, METHOD FOR MANUFACTURING THE SAME AND SILICON CARBIDE SINTERED BODY, METHOD FOR MANUFACTURING THE SAME

the specification for which

☐ is attached hereto.
☒ was filed June 26, 2014, Serial No. 14/369,049.

The above-identified application was made or authorized to be made by me.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified above.

WHEREAS,

Insert

Assignee(s)

LG INNOTEK CO., LTD.,

Name/Address:

a corporation of the country of the Seoul Square, 541, Namdaemunno 5-ga, Jung-gu, Seoul, 100-714, Republic of Korea

(hereinafter ASSIGNEE), is desirous of acquiring the entire right, title, and interest in and to said invention and in and to any Letters Patent which may be granted therefor in the United States and in any and all foreign countries;

Docket No. SUN.LGI.700

NOW, THEREFORE, in view of valuable consideration, receipt of which is hereby acknowledged, I/we, the undersigned, have sold, assigned, and transferred, and by these presents do sell, assign, and transfer, unto said ASSIGNEE, its successors and assigns, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title, and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, and extensions thereof.

I/we hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to ASSIGNEE, as the assignee of the entire right, title, and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its successors and assigns.

FURTHER, I/we agree that we will communicate to said ASSIGNEE, or its representatives, any facts known to me respecting said invention; testify in any legal proceedings; sign all lawful papers; execute all divisional, continuation, substitution, renewal, and reissue applications; execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE; make all rightful oaths; and generally do everything possible to aid the said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

In witness whereof, executed by the undersigned on the date opposite the undersigned name.

Legal Name
of inventor

HAN, Jung Eun

Date:

01 / Sep / 2016

Inventor's
Signature

한 정 은

1. ☒ Additional inventors are being named on the 2 supplemental sheet(s) attached hereto.

**SUPPLEMENTAL SHEET FOR
DECLARATION AND ASSIGNMENT**

ADDITIONAL INVENTOR(S)
Supplemental Sheet Page 1 of 1

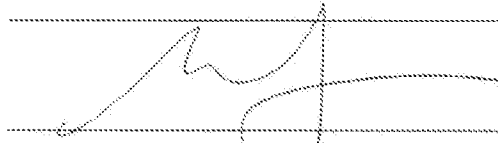
LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name
of inventor **SHIN, Dong Geun**

Date:

Nov. 28 2016

Inventor's
Signature



LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name
of inventor **KIM, Byung Sook**

Date:

Inventor's
Signature

LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name
of inventor

Date:

Inventor's
Signature

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Legal Name
of inventor

Date:

Inventor's
Signature

LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name
of inventor

Date:

Inventor's
Signature

Docket No. SUN.LGI.700

**SUPPLEMENTAL SHEET FOR
DECLARATION AND ASSIGNMENT**

ADDITIONAL INVENTOR(S)
Supplemental Sheet Page 1 of 1

LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name
of inventor

SHIN, Dong Geun

Date:

Inventor's
Signature

LEGAL NAME OF JOINT INVENTOR, IF ANY:

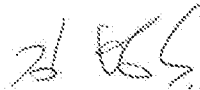
Legal Name
of inventor

KIM, Byung Sook

Date:

01/Sep/2016

Inventor's
Signature



LEGAL NAME OF JOINT INVENTOR, IF ANY:

Legal Name
of inventor

Date:

Inventor's
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